



Fibre-Based Optomechanical Acoustic Sensing

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St. Lucia QLD 4072, Australia



Acoustic Sensor Applications



Acoustic Sensor Applications

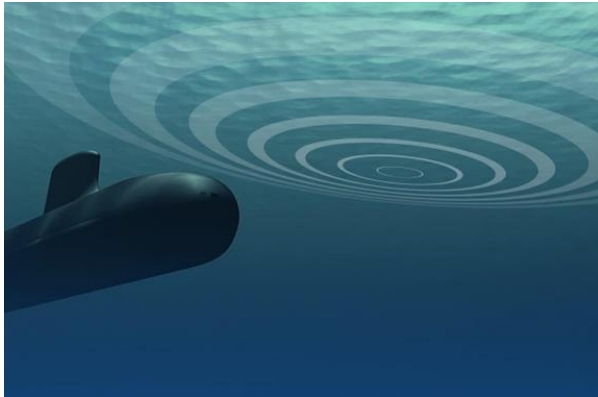
Acoustic sensors have many real-world applications



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SONAR and microphones

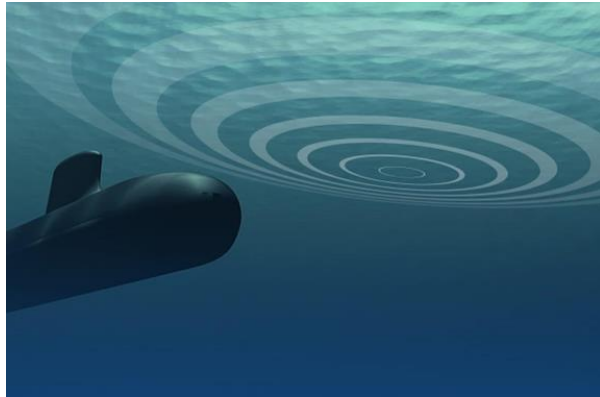


HBK (2022)

Acoustic Sensor Applications



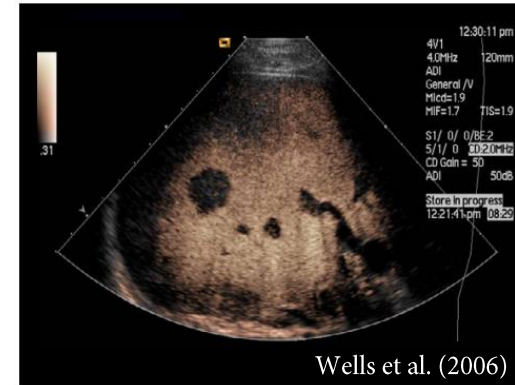
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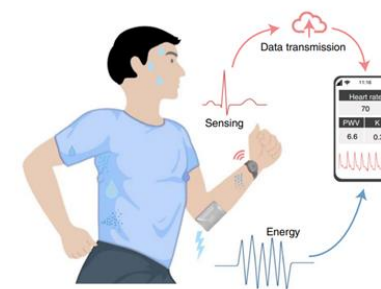
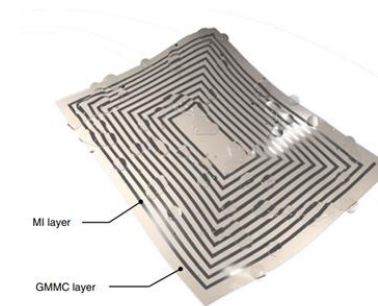


HBK (2022)



Wells et al. (2006)

Biomedical diagnostics

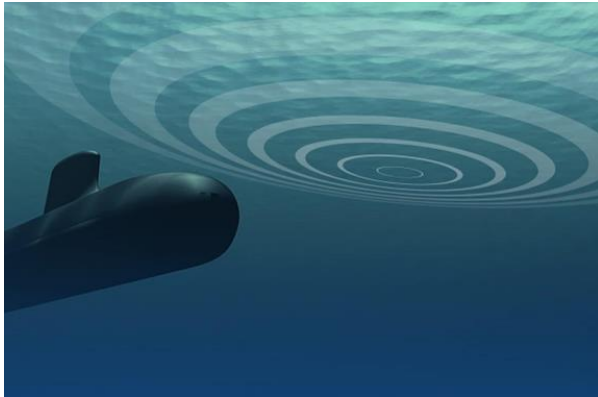


Zhou et al. (2021)

Acoustic Sensor Applications



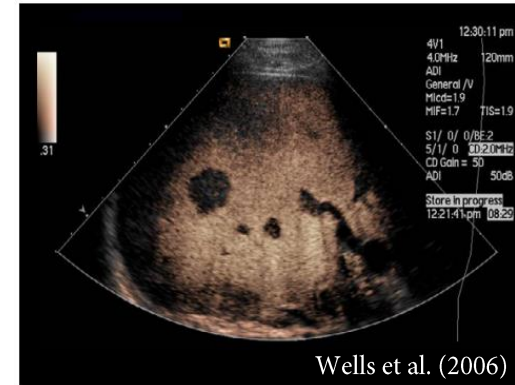
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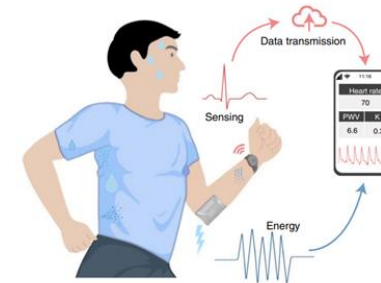
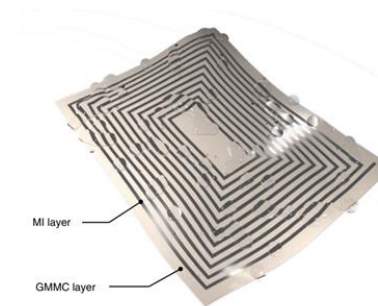


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However, most commercially available sensors are **limited by size (resolution) and electric noise (sensitivity)**

Optomechanical Sensing



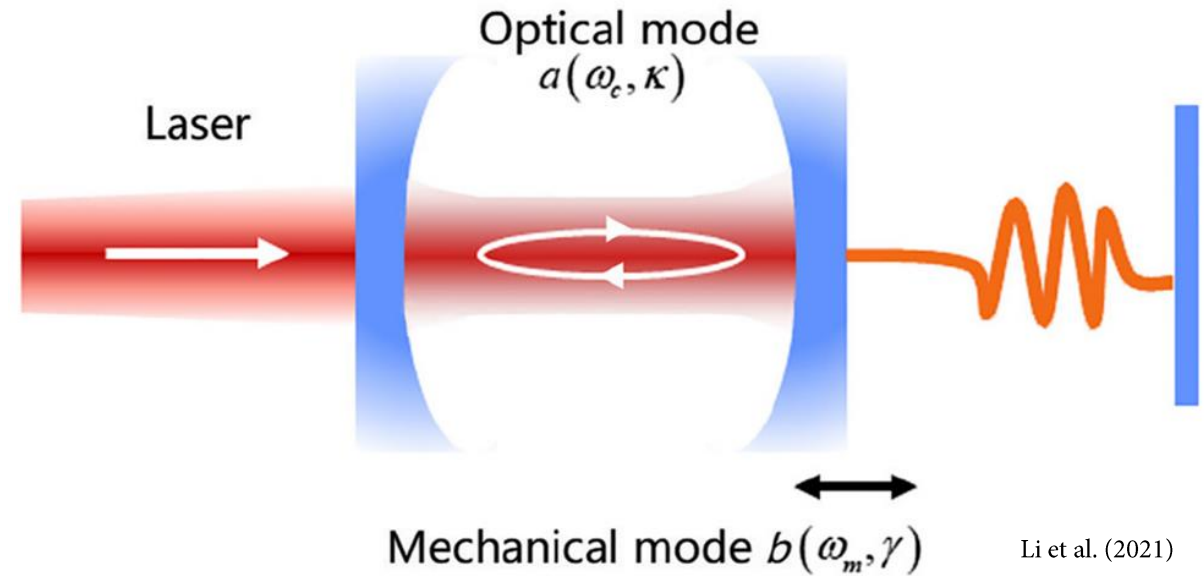
Optomechanical Sensing



Cavity optomechanical ultrasound sensing involves using dual optical and mechanical resonances to enhance the ultrasound signal

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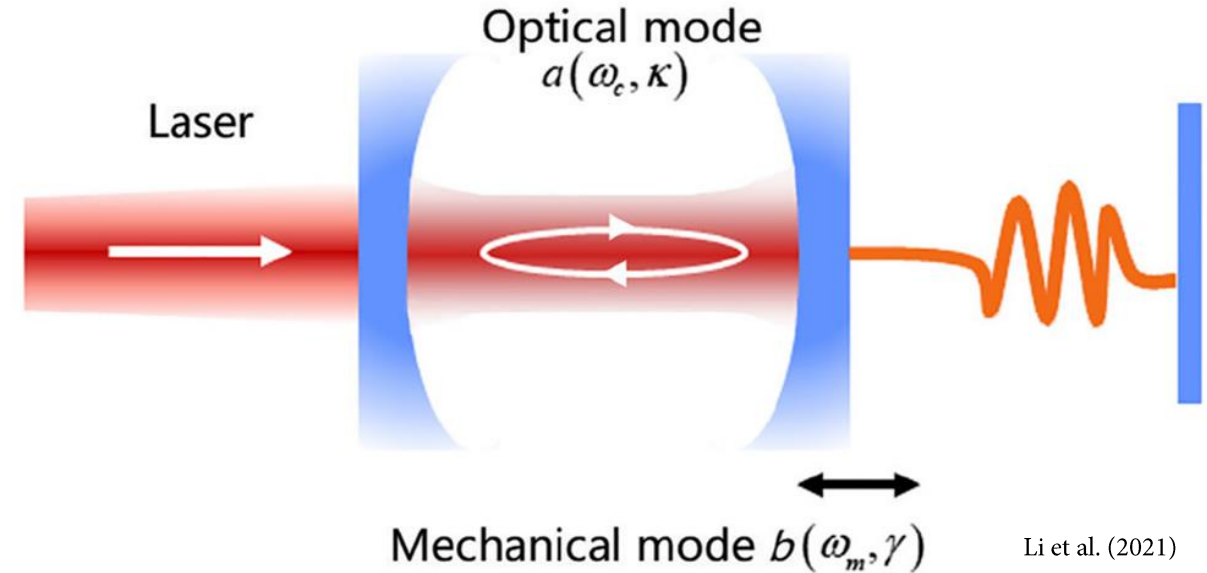
Basic dynamics modelled with Hamiltonian

$$H = H_{\text{drive}} + H_{\text{free}} + H_{\text{int}}$$

Optical driving
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Uncoupled
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Optomechanical Sensing



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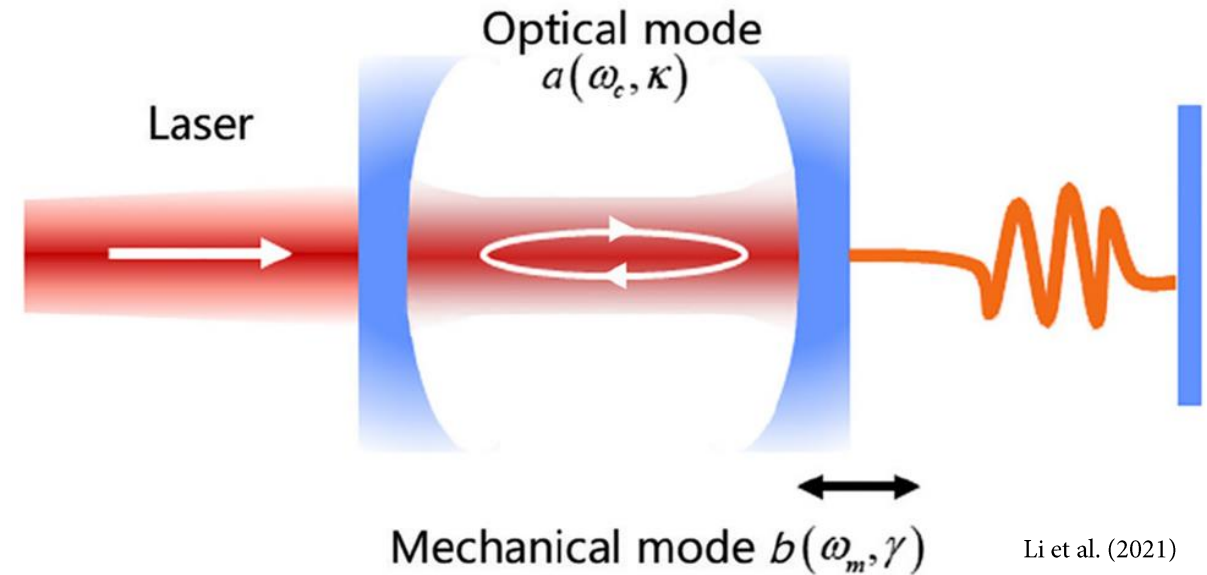
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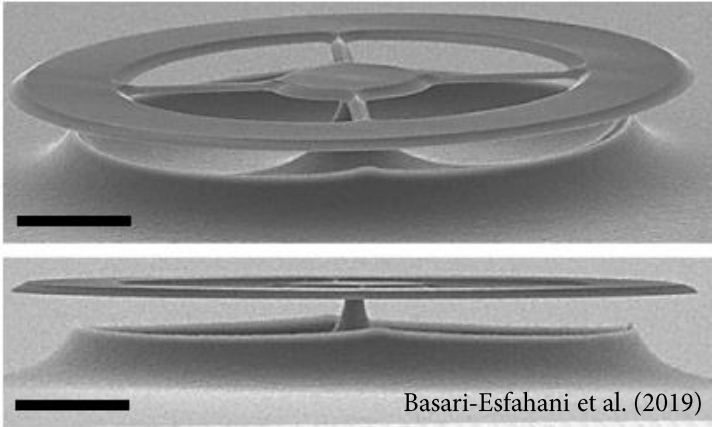
Li et al. (2021)

This approach should result in **improved sensitivity**, and potentially **enable both miniaturisation and increased spatial resolution** of the ultrasound sensors

Optomechanical Acoustic Sensing

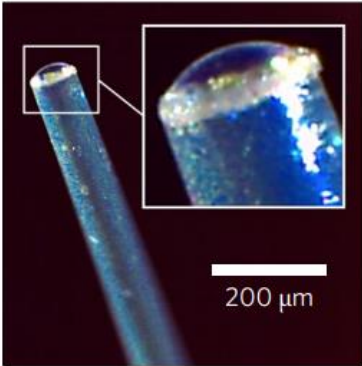
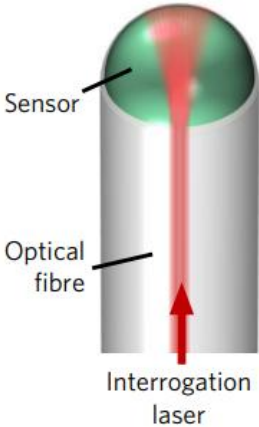


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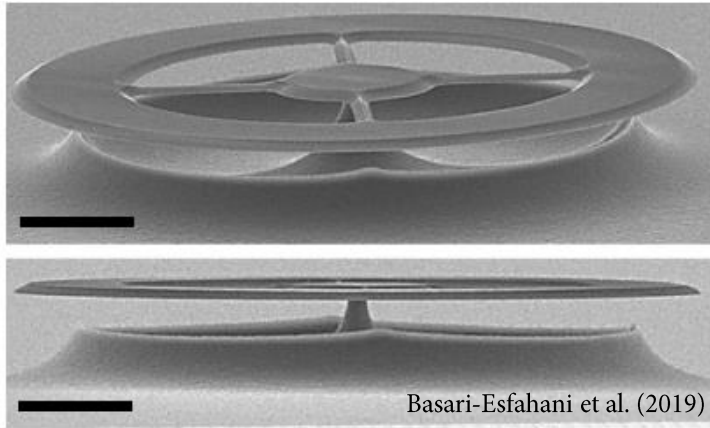
Basari-Esfahani et al. (2019)

Significant milestones in sensitivity achieved, but **limited by robustness** and can be **difficult to mass produce**

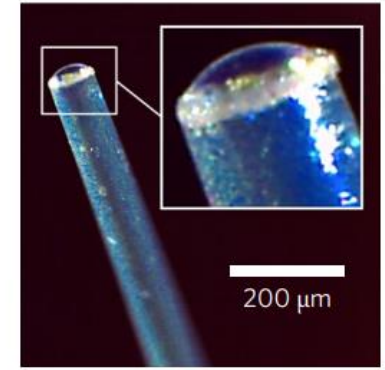
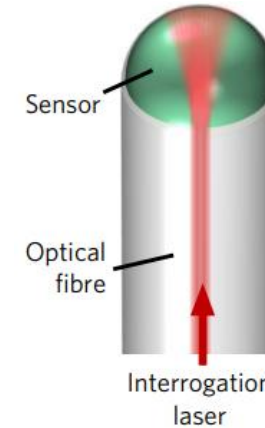


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Optomechanical Acoustic Sensing



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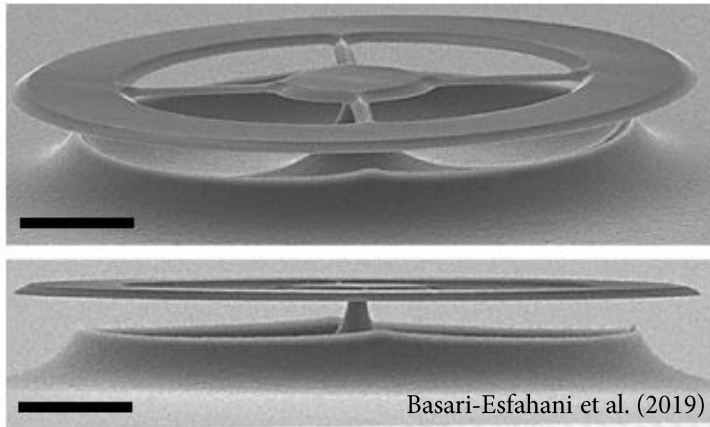
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Silicon-related technology has evolved with the semiconductor industry

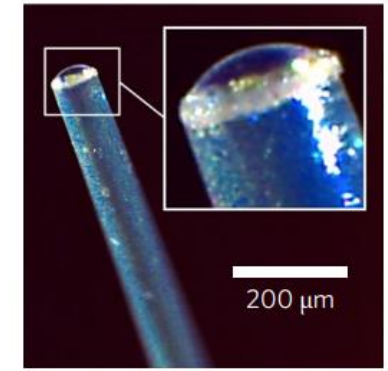
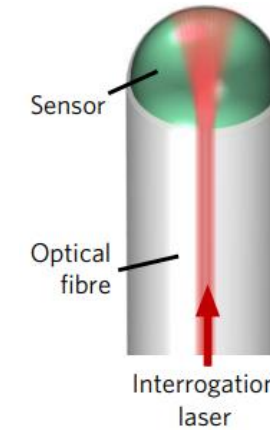


Silicon micro-resonators can be easily fabricated on chip and silicon-on-insulator (SOI) wafers can be massively produced

Optomechanical Acoustic Sensing



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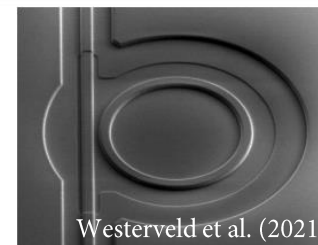
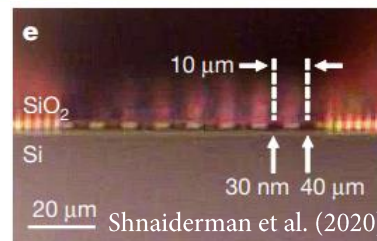
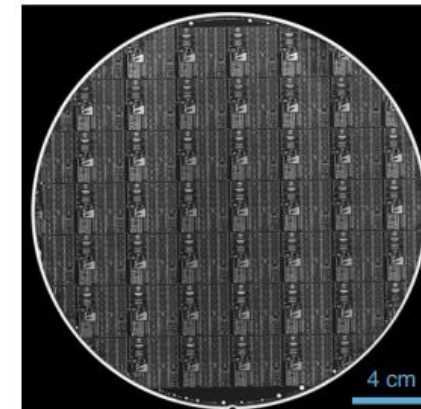
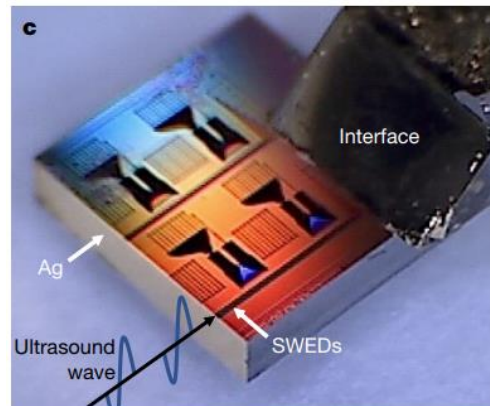


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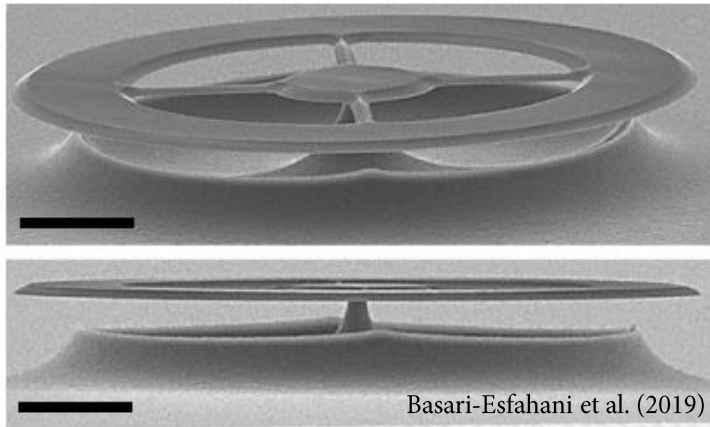
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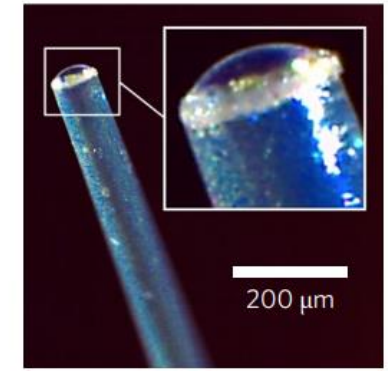
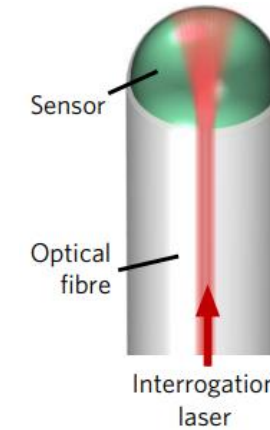
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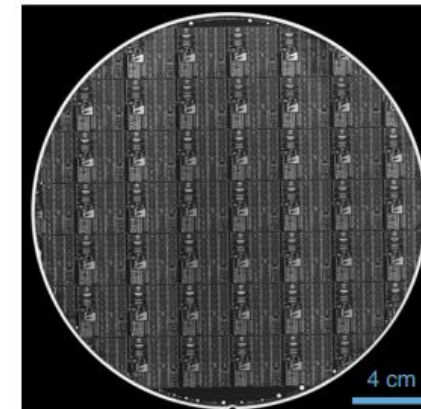
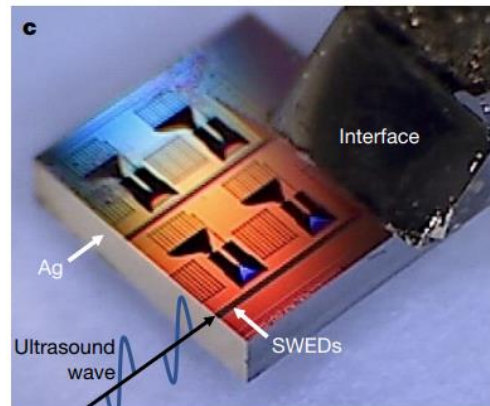


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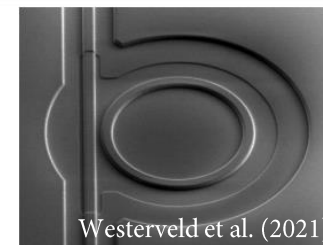
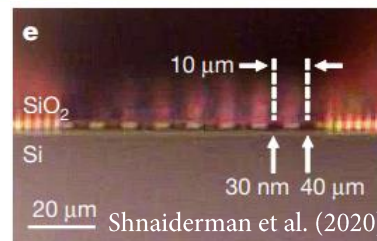
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Silicon micro-resonators can be easily fabricated on chip and silicon-on-insulator (SOI) wafers can be massively produced



However, can be **limited by sensitivity and robustness**



Concept and Architecture

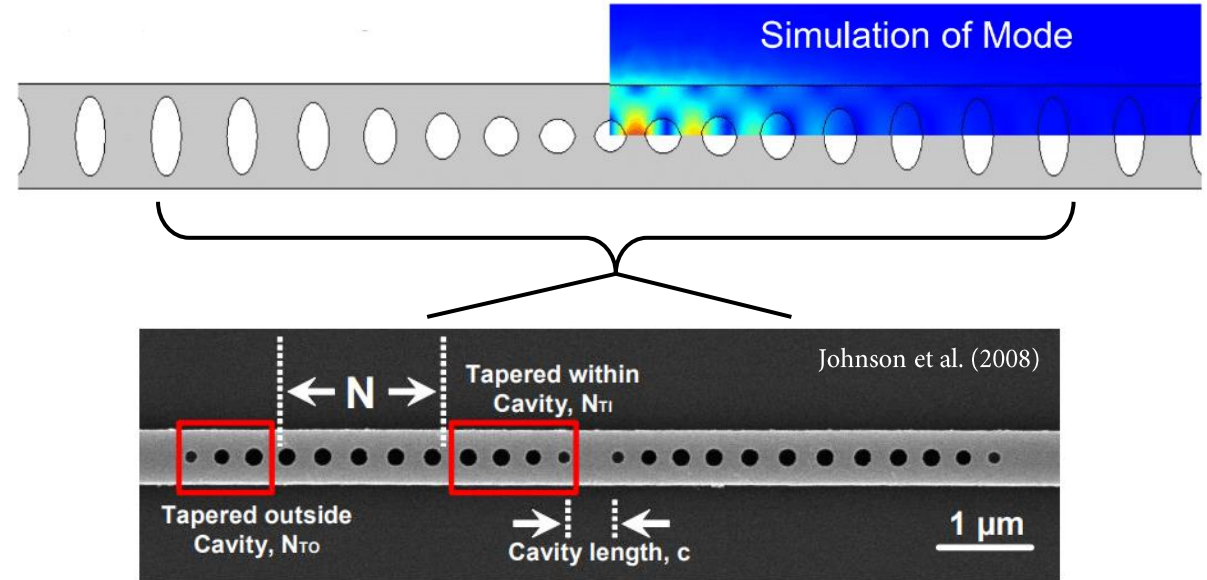


- We develop and demonstrate **acoustic sensing using a nanometre-sized acoustic sensor based on 1D photonic crystals (PhC)**

Concept and Architecture



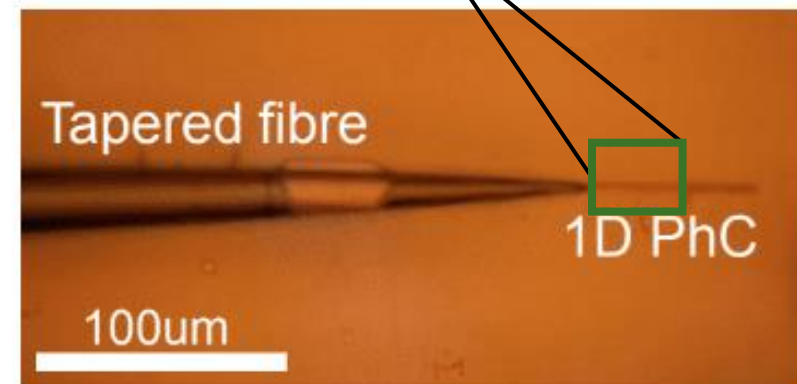
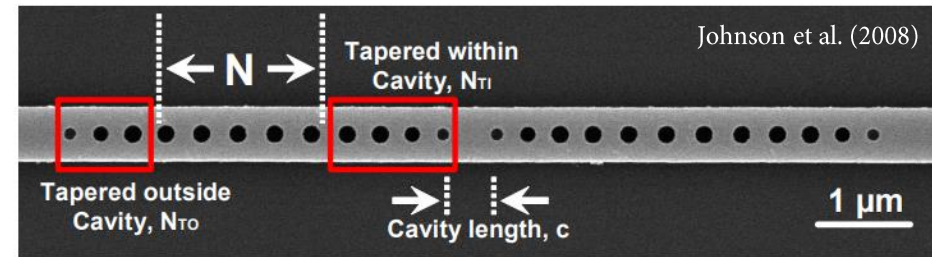
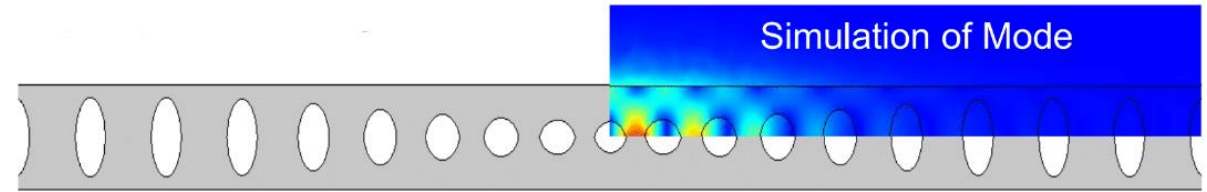
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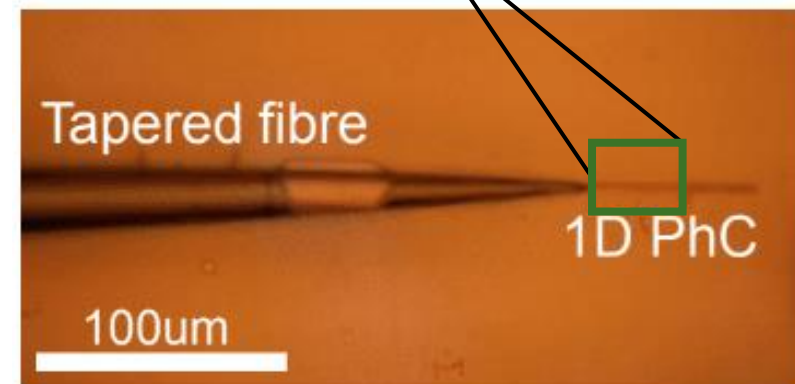
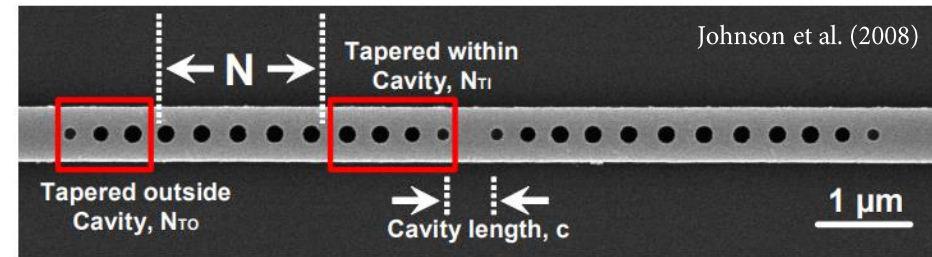
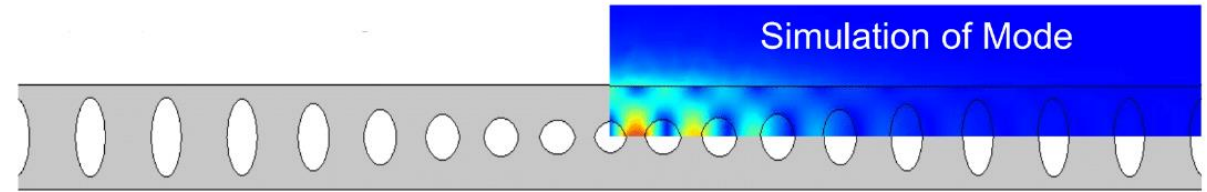
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- Light is coupled into the device waveguide, and the resonant wavelength is trapped in the PhC defect “cavity”



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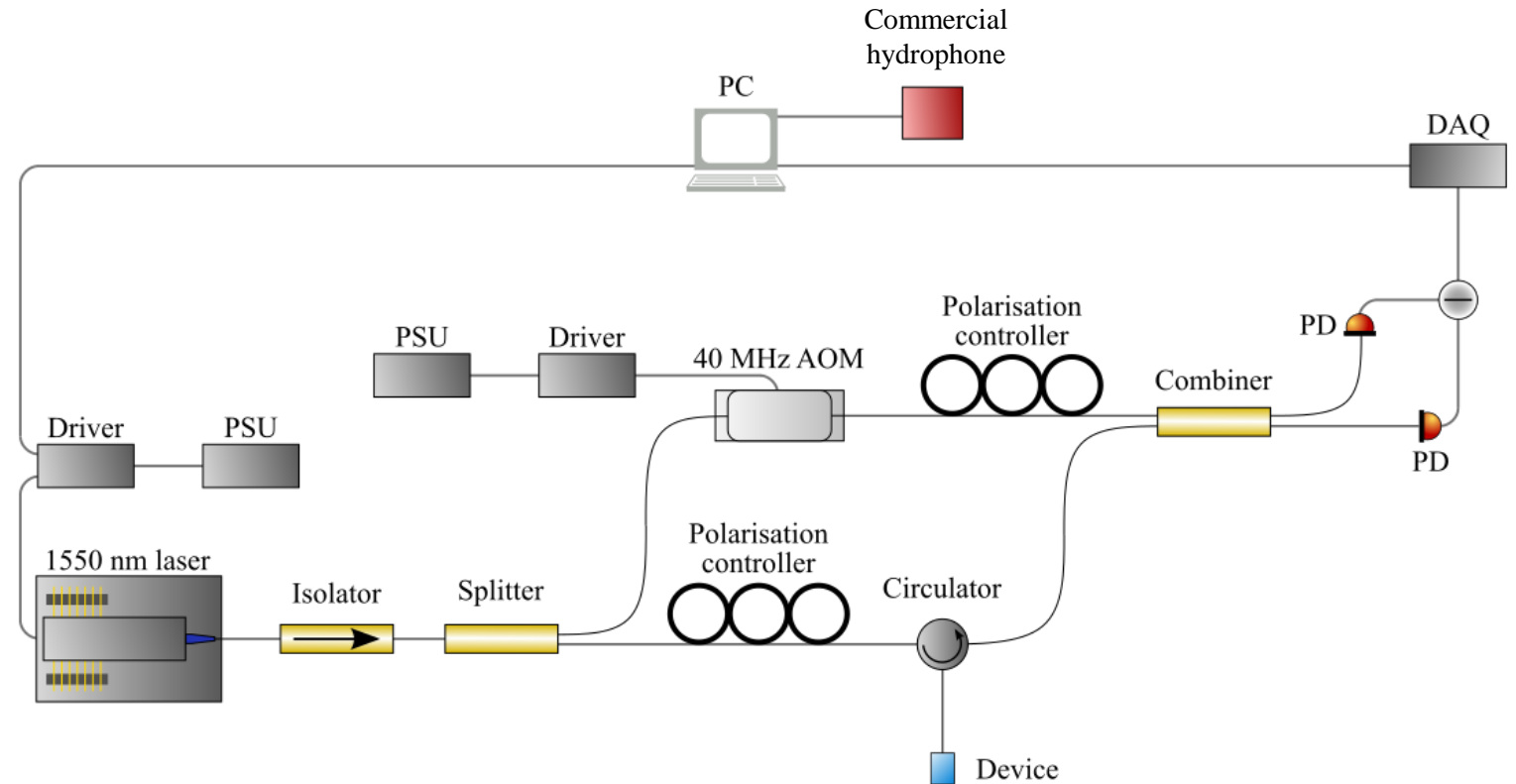
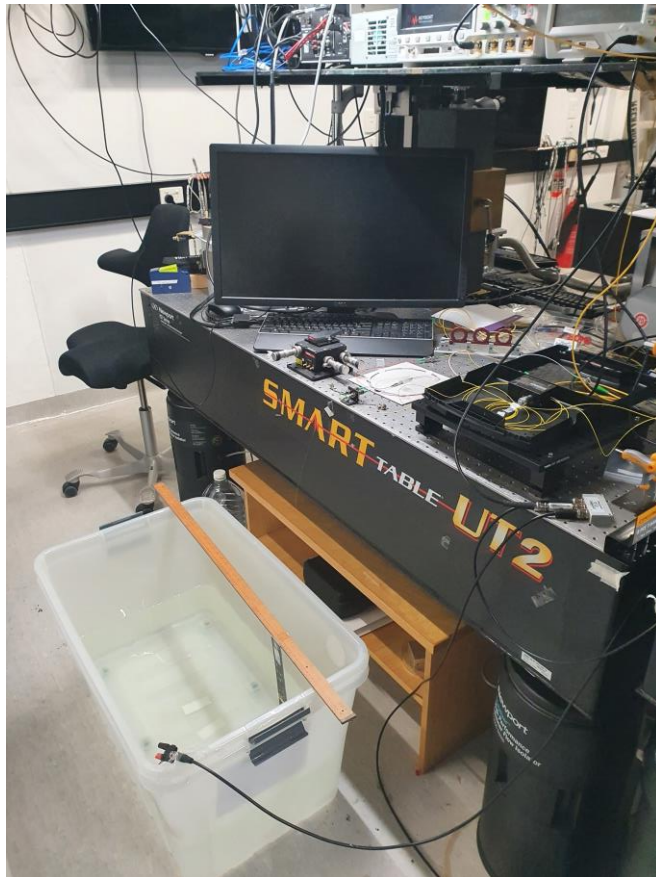
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- Light is coupled into the device waveguide, and the resonant wavelength is trapped in the PhC defect “cavity”
- Acoustic pressure changes the refractive index of the surrounding material, changing the resonant wavelength



Acoustic Characterisation



Acoustic Characterisation



Devices are submerged in bucket of water and response to signal is monitored with heterodyne system

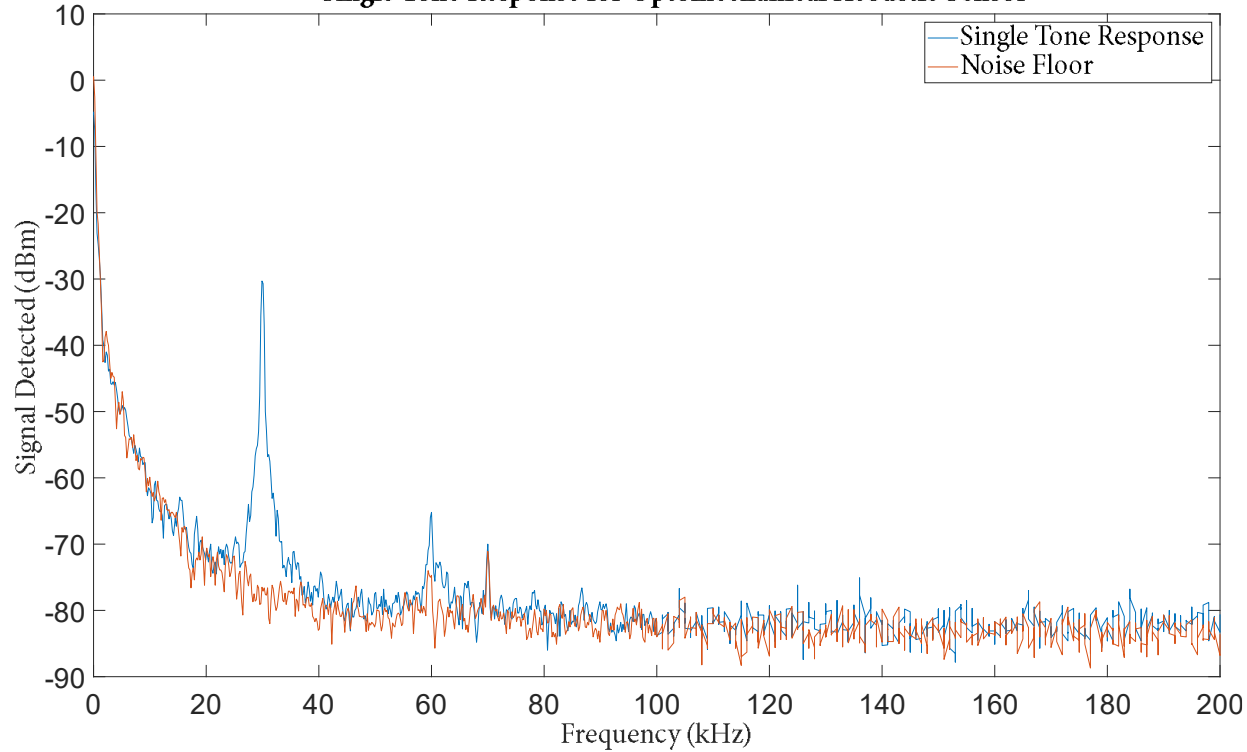
Device Characterisation Results



Device Characterisation Results



Single Tone Response for Optomechanical Acoustic Sensor

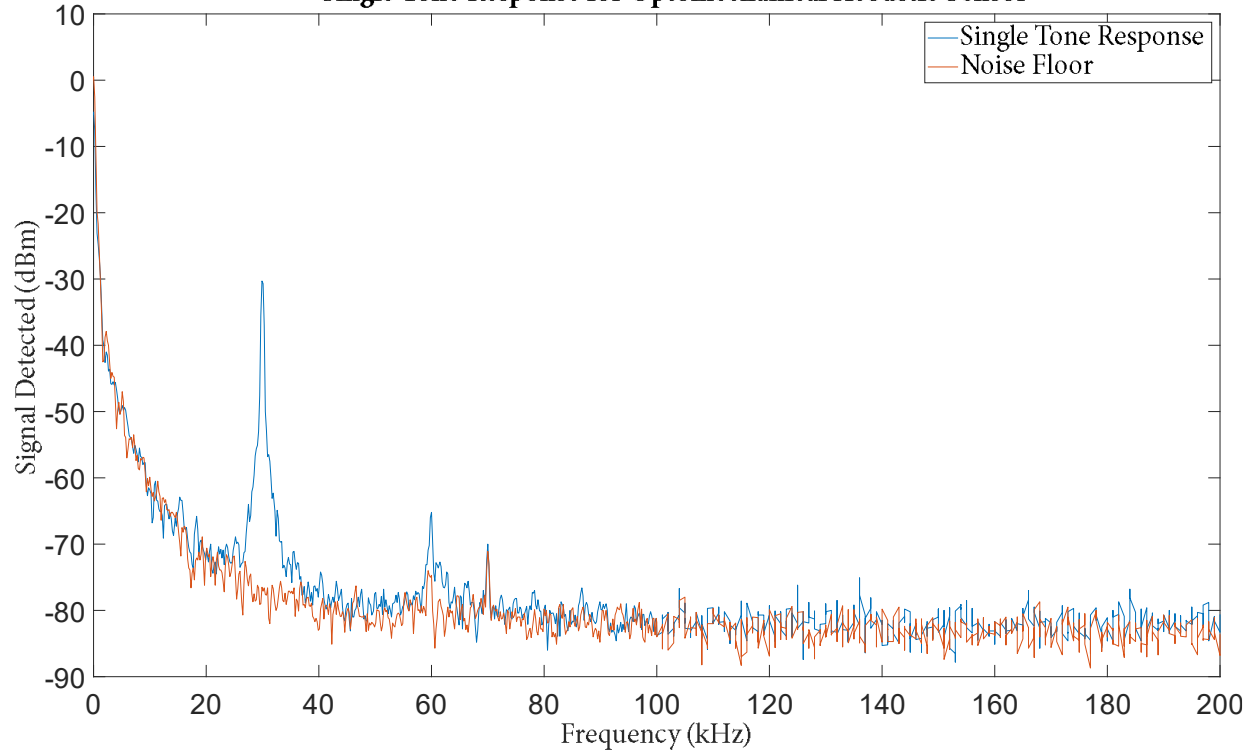


Single tone response at 32 kHz

Device Characterisation Results

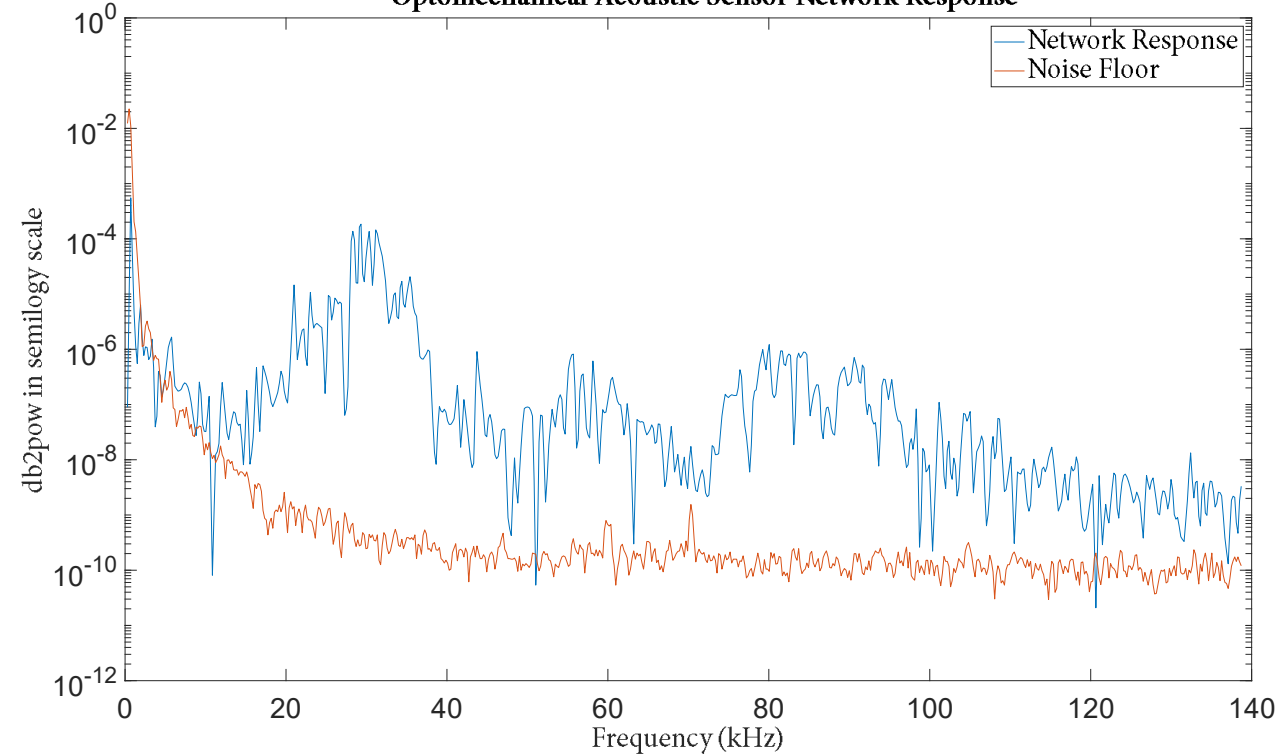


Single Tone Response for Optomechanical Acoustic Sensor



Single tone response at 32 kHz

Optomechanical Acoustic Sensor Network Response



Network response with noise floor measured with spectrum analyser

Device Characterisation Results



Device Characterisation Results



Sensitivity calculated using formula:

$\tau = \Delta f^{-1}$, where Δf is the resolution bandwidth

$$P_{\min}(\omega) = \sqrt{\frac{\tau}{SNR}} \times P_{\text{applied}}(\omega)$$

Signal-to-noise ratio

Applied pressure, modelled with commercial hydrophone

Device Characterisation Results



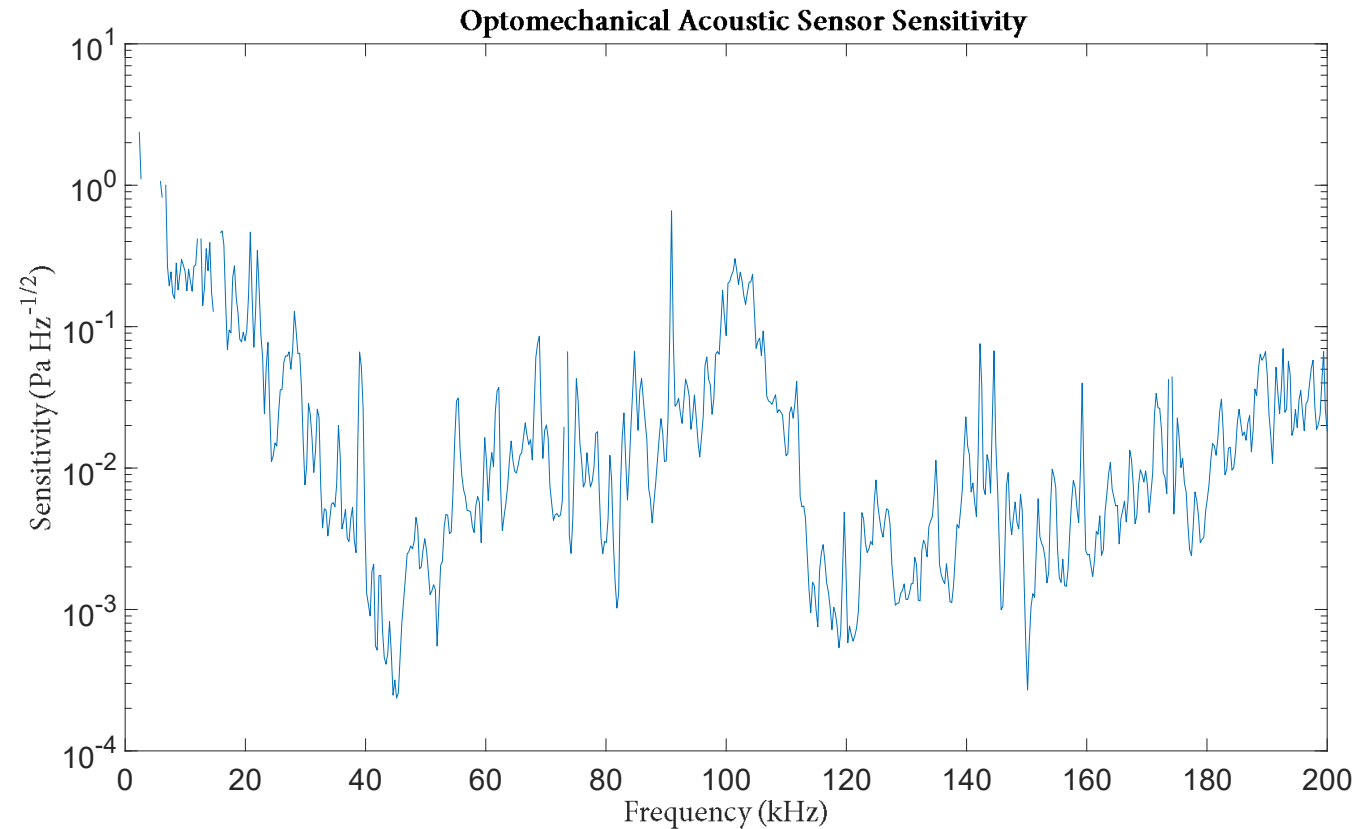
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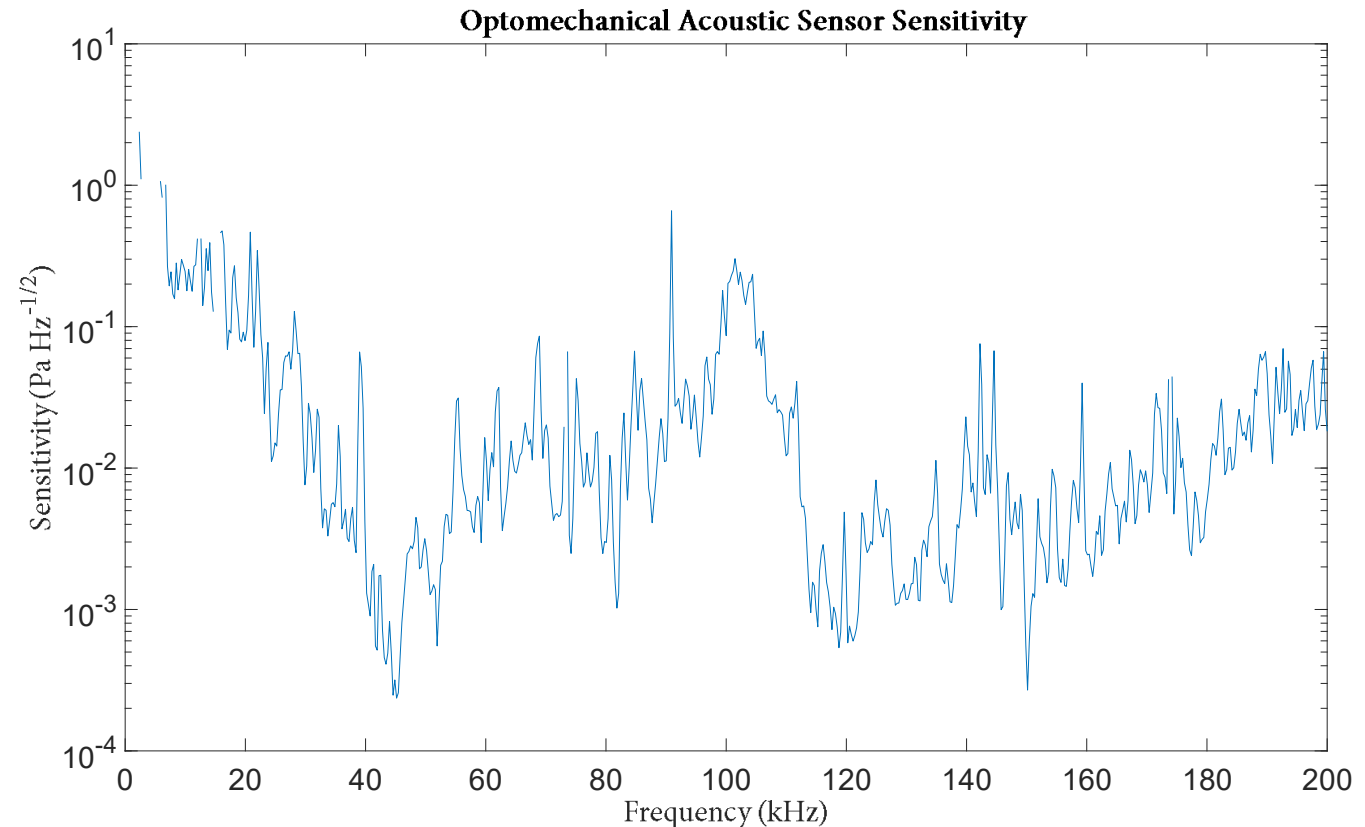
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Optomechanical device demonstrates comparable sensitivity to commercial hydrophone ($\sim \text{mPa}/\sqrt{\text{Hz}}$) but 10 orders of magnitude smaller



Future Outlooks

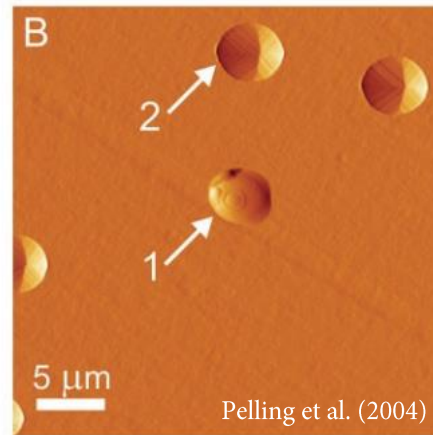
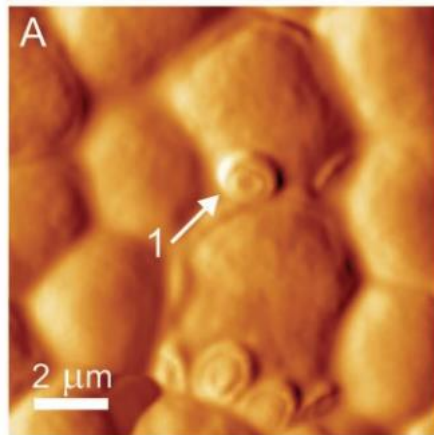


Future Outlooks



Biological sensing applications

- Use fibre-based 1D PhC sensors to try and sense acoustic vibrations from cells
- Currently building set-up for biological sensing

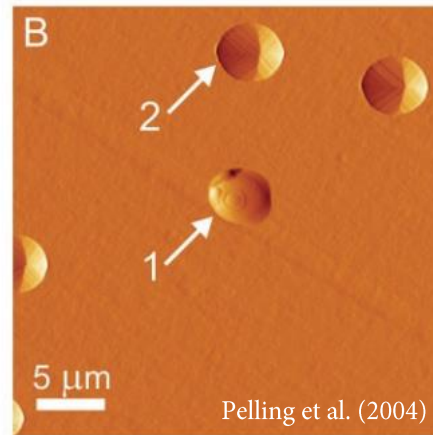
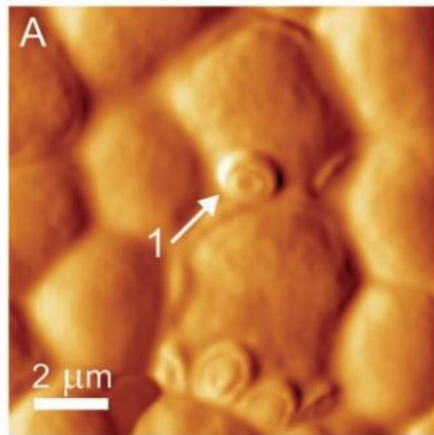


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Defence/engineering applications

- Currently organising for field deployment in UQ swimming pool
- Deploy and characterize fibre-based sensors

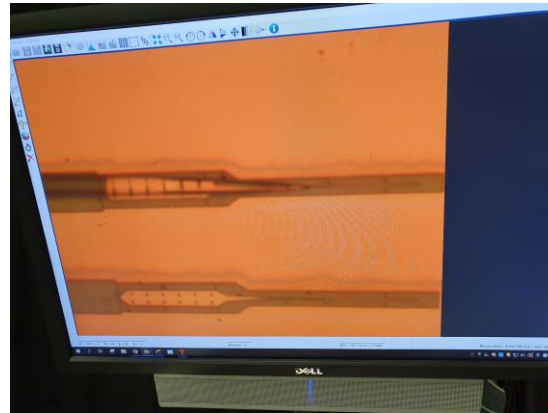


Device Preparation

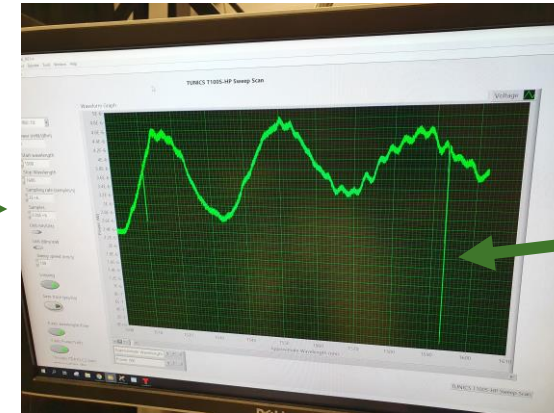


Once devices are fabricated, there are two key next steps:

Device testing



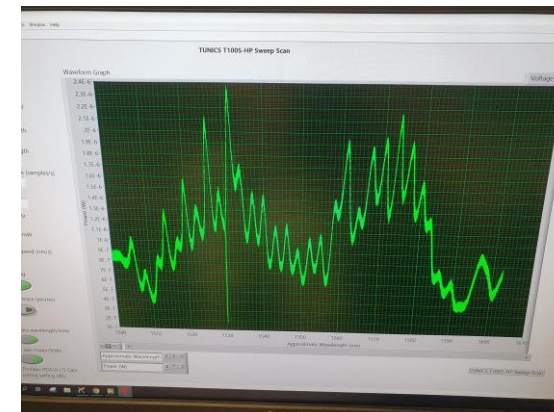
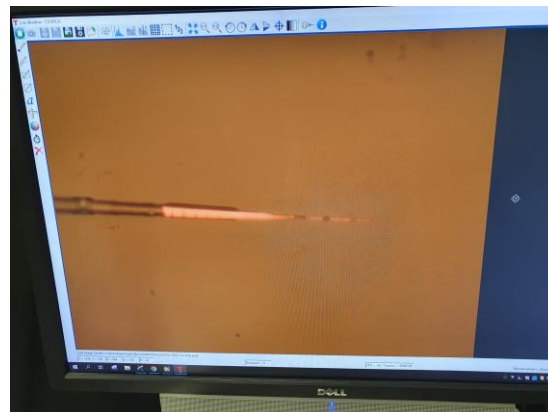
Laser light is coupled to the device



All wavelengths except the resonant wavelength are reflected back

Dips in reflected spectrum are resonances. High quality-factor and dip depth are desirable

Device preparation



Device is lifted off the chip with optical fibre, and then coated in polymer coatings for protection

Testing, Preparation and Characterisation Challenges

